

HCPL-7723/0723

50-MBd 2-ns PWD High-Speed CMOS Optocoupler

Description

Available in either 8-pin DIP or SO.8 package style respectively, the Broadcom[®] HCPL-7723 or HCPL-0723 optocoupler utilize the latest CMOS IC technology to achieve outstanding speed performance of minimum 50 MBd data rate and 2-ns maximum pulse width distortion.

Basic building blocks of HCPL-7723/0723 are a CMOS LED driver IC, a high speed LED and a CMOS detector IC. A CMOS logic input signal controls the LED driver IC, which supplies current to the LED. The detector IC incorporates an integrated photodiode, a high-speed transimpedance amplifier, and a voltage comparator with an output driver.

CAUTION! It is advised that normal static precautions be taken in handling and assembly of this component to prevent damage and/or degradation, which may be induced by ESD. The components featured in this data sheet are not to be used in military or aerospace applications or environments.

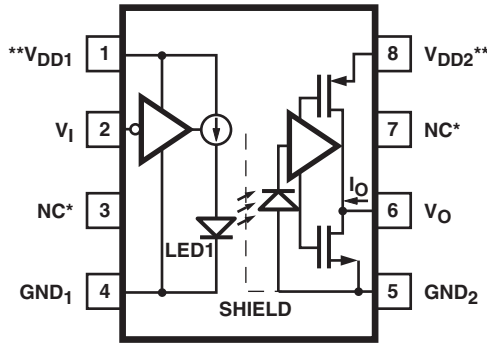
Features

- +5V CMOS compatibility
- High speed: 50 MBd min.
- 2-ns max. pulse width distortion
- 22-ns max. propagation delay
- 16 ns max. propagation delay skew
- 10 kV/ μ s min. common mode rejection
- -40 to 85°C temperature range
- Safety and regulatory approvals:
 - UL recognized:
 - 5000 V_{rms} for 1 min. per UL1577 for HCPL-7723 for option 020
 - 3750 V_{rms} for 1 min. per UL1577 for HCPL-0723
 - CSA component acceptance notice #5
 - IEC/EN/DIN EN 60747-5-5
 - $V_{\text{iorm}} = 630 V_{\text{peak}}$ for HCPL-7723 option 060
 - $V_{\text{iorm}} = 567 V_{\text{peak}}$ for HCPL-0723 option 060

Applications

- Digital fieldbus isolation: CC-Link, DeviceNet, Profibus, SDS, Isolated A/D or D/A conversion
- Multiplexed data transmission
- High-speed digital input/output
- Computer peripheral interface
- Microprocessor system interface

Functional Diagram



* PIN 3 IS THE ANODE OF THE INTERNAL LED AND MUST BE LEFT UNCONNECTED FOR GUARANTEED DATASHEET PERFORMANCE. PIN 7 IS NOT CONNECTED INTERNALLY.

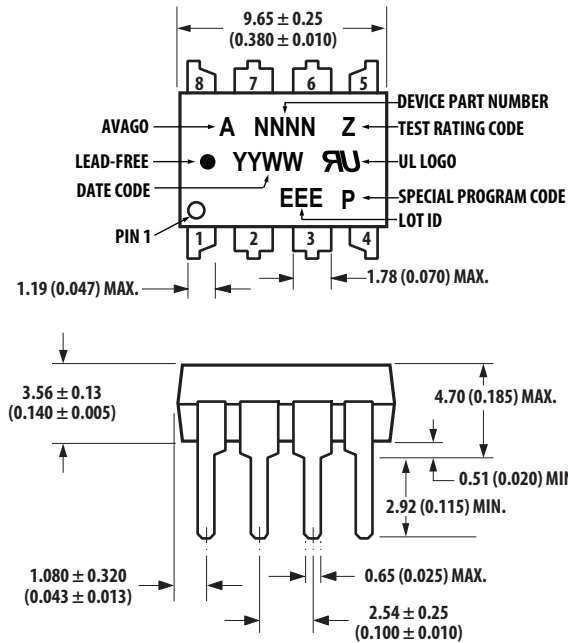
** A 0.01 to 0.1 μ F BYPASS CAPACITOR MUST BE CONNECTED AS CLOSE AS POSSIBLE BETWEEN PINS 1 AND 4, AND 5 AND 8.

Truth Table

| V_I Input | LED1 | V_O Output |
|-------------|------|--------------|
| H | OFF | H |
| L | ON | L |

Package Outline Drawings

HCPL-7723 8-Pin DIP Package



DIMENSIONS IN MILLIMETERS (INCHES).

*MARKING CODE LETTER FOR OPTION NUMBERS

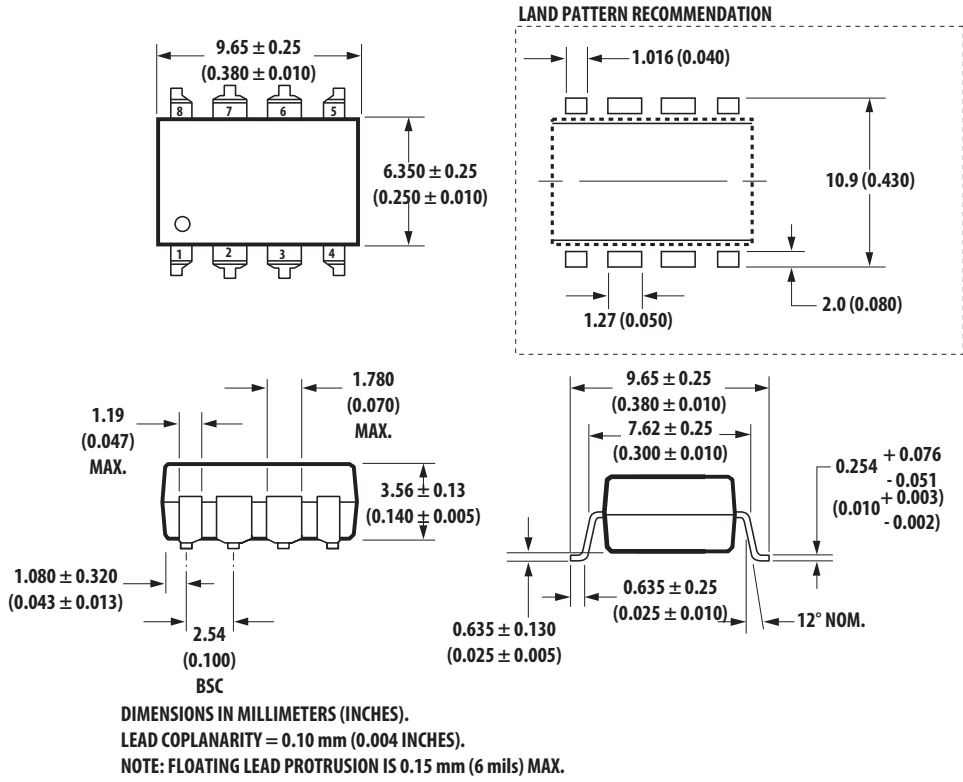
"L" = OPTION 020

"V" = OPTION 060

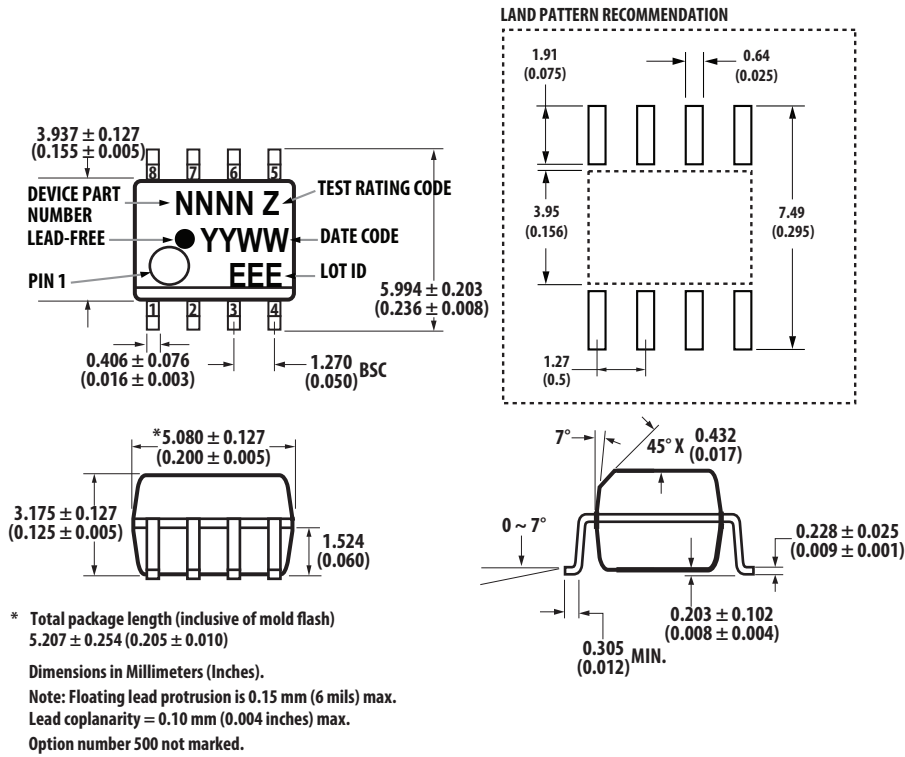
OPTION NUMBERS 300 AND 500 NOT MARKED.

NOTE: FLOATING LEAD PROTRUSION IS 0.25 mm (10 mils) MAX.

HCPL-7723 Package with Gull Wing Surface Mount Option 300



HCPL-0723 Small Outline SO-8 Package



Device Selection Guide

| 8-Pin DIP (300 mil) | Small Outline SO-8 |
|---------------------|--------------------|
| HCPL-7723 | HCPL-0723 |

Ordering Information

HCPL-0723 and HCPL-7723 are UL Recognized with 3750 Vrms for 1 minute per UL1577.

| Part Number | Option | | Package | Surface Mount | Gull Wing | Tape and Reel | UL5000 Vrms / 1 Minute Rating | IEC/EN/DIN EN 60747-5-5 | Quantity |
|-------------|----------------|--------------------|---------------|---------------|-----------|---------------|-------------------------------|-------------------------|---------------|
| | RoHS Compliant | Non RoHS Compliant | | | | | | | |
| HCPL-7723 | -000E | no option | 300 mil DIP-8 | | | | | | 50 per tube |
| | -300E | -300 | | X | X | | | | 50 per tube |
| | -500E | -500 | | X | X | X | | | 1000 per reel |
| | -020E | -020 | | | | | X | | 50 per tube |
| | -320E | -320 | | X | X | | X | | 50 per tube |
| | -520E | -520 | | X | X | X | X | | 1000 per reel |
| | -060E | -060 | | | | | | X | 50 per tube |
| | -360E | -360 | | X | X | | | X | 50 per tube |
| | -560E | -560 | | X | X | X | | X | 1000 per reel |
| HCPL-0723 | -000E | no option | SO-8 | X | | | | | 100 per tube |
| | -500E | -500 | | X | | X | | | 1500 per reel |
| | -060E | -060 | | X | | | | X | 100 per tube |
| | -560E | -560 | | X | | X | | X | 1500 per reel |

To order, choose a part number from the part number column and combine with the desired option from the option column to form an order entry.

Example 1:

HCPL-7723-560E to order product of Gull Wing Surface Mount package in Tape and Reel packaging with IEC/EN/DIN EN 60747-5-5 Safety Approval and RoHS compliant.

Example 2:

HCPL-0723 to order product of Small Outline SO-8 package in Tube packaging and non RoHS compliant.

Option data sheets are available. Contact your Broadcom sales representative or authorized distributor for information.

NOTE: The notation #XXX is used for existing products, while (new) products launched since July 15, 2001 and RoHS compliant will use -XXE.

Regulatory Information

The HCPL-7723/0723 have been approved by the following organizations:

- **UL** — Recognized under UL1577, component recognition program, File E55361.
- **CSA** — Approval under CSA Component Acceptance Notice #5, File CA88324.
- **IEC/EN/DIN EN 60747-5-5** — Approved with Maximum Working Insulation Voltage:
 - $V_{iorm} = 567 V_{peak}$ for HCPL-0723
 - $V_{iorm} = 630 V_{peak}$ for HCPL-7723

Solder Reflow Profile

Recommended reflow condition as per JEDEC Standard, J-STD-020 (latest revision). Non-Halide Flux should be used.

Insulation and Safety Related Specifications

| Parameter | Symbol | Value | | Unit | Conditions |
|---|--------|-------|------|------|---|
| | | 7723 | 0723 | | |
| Minimum External Air Gap (Clearance) | L(I01) | 7.1 | 4.9 | mm | Measured from input terminals to output terminals, shortest distance through air. |
| Minimum External Tracking (Creepage) | L(I02) | 7.4 | 4.8 | mm | Measured from input terminals to output terminals, shortest distance path along body. |
| Minimum Internal Plastic Gap (Internal Clearance) | | 0.08 | 0.08 | mm | Insulation thickness between emitter and detector; also known as distance through insulation. |
| Tracking Resistance (Comparative Tracking Index) | CTI | ≥175 | ≥175 | V | DIN IEC 112/VDE 0303 Part 1. |
| Isolation Group | | IIIa | IIIa | | Material Group (DIN VDE 0110, 1/89, Table 1). |

All Broadcom data sheets report the creepage and clearance inherent to the optocoupler component itself. These dimensions are needed as a starting point for the equipment designer when determining the circuit insulation requirements. However, once mounted on a printed circuit board, minimum creepage and clearance requirements must be met as specified for individual equipment standards. For creepage, the shortest distance path along the surface of a printed circuit board between the solder fillets of the input and output leads must be considered. There are recommended techniques such as grooves and ribs, which may be used on a printed circuit board to achieve desired creepage and clearances. Creepage and clearance distances will also change depending on factors such as pollution degree and insulation level.

IEC/EN/DIN EN 60747-5-5 Insulation Characteristics (Option 060)

| Description | Symbol | Characteristic | | Unit |
|---|-----------------|-----------------------------|------------------------------|-------------|
| | | HCPL-7723 | HCPL-0723 | |
| Installation Classification per DIN VDE 0110/39, Table 1 For Rated Mains Voltage $\leq 150V_{rms}$ For Rated Mains Voltage $\leq 300V_{rms}$ For Rated Mains Voltage $\leq 600V_{rms}$ | | I – IV I – III I – IV | I – IV I – III I – III | |
| Climatic Classification | | 55/85/21 | 55/85/21 | |
| Pollution Degree (DIN VDE 0110/39) | | 2 | 2 | |
| Maximum Working Insulation Voltage | V_{IORM} | 630 | 567 | V_{peak} |
| Input to Output Test Voltage, Method b ^a $V_{IORM} \times 1.875 = V_{PR}$, 100% Production Test with $t_m = 1s$, Partial Discharge $< 5 pC$ | V_{PR} | 1181 | 1063 | V_{peak} |
| Input to Output Test Voltage, Method a ^a $V_{IORM} \times 1.6 = V_{PR}$, Type and Sample Test, $t_m = 10s$, Partial Discharge $< 5 pC$ | V_{PR} | 1008 | 907 | V_{peak} |
| Highest Allowable Overvoltage (Transient Overvoltage $t_{ini} = 60s$) | V_{IOTM} | 8000 | 6000 | V_{peak} |
| Safety-Limiting Values – Maximum Values Allowed in the Event of a Failure | | | | |
| Case Temperature | T_S | 175 | 150 | $^{\circ}C$ |
| Input Current | $I_{S, INPUT}$ | 230 | 150 | mA |
| Output Power | $P_{S, OUTPUT}$ | 600 | 600 | mW |
| Insulation Resistance at T_S , $V_{IO} = 500V$ | R_S | $\geq 10^9$ | $\geq 10^9$ | Ω |

a. Refer to the optocoupler section of the Isolation and Control Component Designer's Catalog, under Product Safety Regulations section IEC/EN/DIN EN 60747-5-5, for a detailed description of Method a and Method b partial discharge test profiles.

NOTE: These optocouplers are suitable for safe electrical isolation only within the safety limit data. Maintenance of the safety data is ensured by means of protective circuits.

Absolute Maximum Ratings

| Parameter | Symbol | Min. | Max. | Unit |
|--|--|------|-----------------|------|
| Storage Temperature | T_S | -55 | 125 | °C |
| Ambient Operating Temperature ^a | T_A | -40 | 85 | °C |
| Supply Voltages | V_{DD1}, V_{DD2} | 0 | 6.0 | V |
| Input Voltage | V_I | -0.5 | $V_{DD1} + 0.5$ | V |
| Output Voltage | V_O | -0.5 | $V_{DD2} + 0.5$ | V |
| Average Output Current | I_O | — | 10 | mA |
| Lead Solder Temperature | 260°C for 10 sec., 1.6 mm below seating plane. | | | |
| Solder Reflow Temperature Profile | See Solder Reflow Profile section. | | | |

a. Absolute maximum ambient operating temperature means the device will not be damaged if operated under these conditions. It does not guarantee functionality

Recommended Operating Conditions

| Parameter | Symbol | Min. | Max. | Unit |
|----------------------------------|--------------------|------|-----------|------|
| Ambient Operating Temperature | T_A | -40 | 85 | °C |
| Supply Voltages | V_{DD1}, V_{DD2} | 4.5 | 5.5 | V |
| Logic High Input Voltage | V_{IH} | 2.0 | V_{DD1} | V |
| Logic Low Input Voltage | V_{IL} | 0.0 | 0.8 | V |
| Input Signal Rise and Fall Times | t_{ir}, t_{if} | — | 1.0 | ms |

Electrical Specifications

Test conditions that are not specified can be anywhere within the recommended operating range.

All typical specifications are at $T_A = +25^\circ\text{C}$, $V_{DD1} = V_{DD2} = +5\text{V}$.

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
|--|------------|------|------|------|------|--|
| Logic Low Input Supply Current ^a | I_{DD1L} | — | 8.4 | 10 | mA | $V_I = 0\text{V}$; Figure 1 |
| Logic High Input Supply Current ^a | I_{DD1H} | — | 0.6 | 3 | mA | $V_I = V_{DD1}$; Figure 2 |
| Output Supply Current | I_{DD2L} | — | 2.1 | 5 | mA | Figure 3 |
| | I_{DD2H} | — | 2.0 | 5 | mA | Figure 4 |
| Input Current | I_I | -10 | — | 10 | μA | |
| Logic High Output Voltage | V_{OH} | 4.4 | 5.0 | — | V | $I_O = -20\ \mu\text{A}$, $V_I = V_{IH}$ |
| | | 4.0 | 4.8 | — | V | $I_O = -4\ \text{mA}$, $V_I = V_{IH}$ |
| Logic Low Output Voltage | V_{OL} | — | 0 | 0.1 | V | $I_O = 20\ \mu\text{A}$, $V_I = V_{IL}$ |
| | | — | 0.5 | 1.0 | V | $I_O = 4\ \text{mA}$, $V_I = V_{IL}$ |

a. The LED is ON when V_I is low and OFF when V_I is high.

Switching Specifications

Test conditions that are not specified can be anywhere within the recommended operating range.

All typical specifications are at $T_A = +25^\circ\text{C}$, $V_{DD1} = V_{DD2} = +5\text{V}$.

| Parameter | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
|--|-----------|------|------|------|-------------------|---|
| Propagation Delay Time to Logic Low Output ^a | t_{PHL} | — | 16 | 22 | ns | $C_L = 15\text{ pF}$ CMOS Signal Levels; Figure 5 |
| Propagation Delay Time to Logic High Output ^a | t_{PLH} | — | 16 | 22 | ns | $C_L = 15\text{ pF}$ CMOS Signal Levels; Figure 5 |
| Pulse Width | PW | 20 | — | — | ns | $C_L = 15\text{ pF}$ CMOS Signal Levels |
| Maximum Data Rate | | 50 | — | — | MBd | $C_L = 15\text{ pF}$ CMOS Signal Levels |
| Pulse Width Distortion ^b $ t_{PHL} - t_{PLH} $ | PWD | — | 1 | 2 | ns | $C_L = 15\text{ pF}$ CMOS Signal Levels; Figure 6 |
| Propagation Delay Skew ^c | t_{PSK} | — | — | 16 | ns | $C_L = 15\text{ pF}$ CMOS Signal Levels |
| Output Rise Time (10% to 90%) | t_R | — | 8 | — | ns | $C_L = 15\text{ pF}$ CMOS Signal Levels |
| Output Fall Time (90% to 10%) | t_F | — | 6 | — | ns | $C_L = 15\text{ pF}$ CMOS Signal Levels |
| Common Mode Transient Immunity at Logic High Output ^d | $ CM_H $ | 10 | 15 | — | kV/ μs | $V_{CM} = 1000\text{V}$, $T_A = 25^\circ\text{C}$, $V_I = V_{DD1}$, $V_O > 0.8 V_{DD2}$ |
| Common Mode Transient Immunity at Logic Low Output ^d | $ CM_L $ | 10 | 15 | — | kV/ μs | $V_{CM} = 1000\text{V}$, $T_A = 25^\circ\text{C}$, $V_I = 0\text{V}$, $V_O < 0.8\text{V}$ |

- t_{PHL} propagation delay is measured from the 50% level on the falling edge of the V_I signal to the 50% level of the falling edge of the V_O signal. t_{PLH} propagation delay is measured from the 50% level on the rising edge of the V_I signal to the 50% level of the rising edge of the V_O signal.
- PWD is defined as $|t_{PHL} - t_{PLH}|$. %PWD (percent pulse width distortion) is equal to the PWD divided by pulse width.
- t_{PSK} is equal to the magnitude of the worst-case difference in t_{PHL} and/or t_{PLH} that will be seen between units at any given temperature within the recommended operating conditions.
- CM_H is the maximum common mode voltage slew rate that can be sustained while maintaining $V_O > 0.8V_{DD2}$. CM_L is the maximum common mode voltage slew rate that can be sustained while maintaining $V_O < 0.8\text{V}$. The common mode voltage slew rates apply to both rising and falling common mode voltage edges.

Package Characteristics

All typical specifications are at $T_A = 25^\circ\text{C}$.

| Parameter | | Symbol | Min. | Typ. | Max. | Unit | Test Conditions |
|---|------------|----------------|------|-----------|------|--------------------|---|
| Input-Output Momentary Withstand Voltage ^{a, b, c} | -7723 | V_{ISO} | 3750 | — | — | V_{rms} | $RH \leq 50\%$, $t = 1 \text{ min}$, $T_A = 25^\circ\text{C}$ |
| | Option 020 | | 5000 | — | — | | |
| | -0723 | | 3750 | — | — | | |
| Input-Output Resistance ^a | | R_{I-O} | — | 10^{12} | — | Ω | $V_{I-O} = 500 \text{ Vdc}$ |
| Input-Output Capacitance | | C_{I-O} | — | 0.6 | — | pF | $f = 1 \text{ MHz}$ |
| Input Capacitance ^d | | C_I | — | 3.0 | — | pF | |
| Input IC Junction-to-Case Thermal Resistance | -7723 | θ_{jci} | — | 145 | — | $^\circ\text{C/W}$ | Thermocouple located at center underside of package |
| | -0723 | | — | 160 | — | | |
| Output IC Junction-to-Case Thermal Resistance | -7723 | θ_{jco} | — | 145 | — | $^\circ\text{C/W}$ | |
| | -0723 | | — | 135 | — | | |
| Package Power Dissipation | | P_{PD} | — | — | 150 | mW | |

- a. Device considered a two-terminal device: pins 1, 2, 3, and 4 shorted together and pins 5, 6, 7, and 8 shorted together.
- b. In accordance with UL1577, each HCPL-0723 is proof tested by applying an insulation test voltage $\geq 4500 V_{rms}$ for 1 second (leakage detection current limit, $I_{I-O} \leq 5 \mu\text{A}$). Each HCPL-7723 is proof tested by applying an insulation test voltage $\geq 4500 V_{rms}$ for 1 second (leakage detection current limit, $I_{I-O} \leq 5 \mu\text{A}$.)
- c. The Input-Output Momentary Withstand Voltage is a dielectric voltage rating that should not be interpreted as an input-output continuous voltage rating. For the continuous voltage rating, refer to your equipment level safety specification or Broadcom Application Note 1074, Optocoupler Input-Output Endurance Voltage.
- d. C_I is the capacitance measured at pin 2 (V_I).

Figure 1: Typical Logic Low Input Supply Current vs. Temperature



Figure 2: Typical Logic High Input Supply Current vs. Temperature



Figure 3: Typical Logic Low Output Supply Current vs. Temperature



Figure 4: Typical Logic High Output Supply Current vs. Temperature



Figure 5: Typical Propagation Delay vs. Temperature



Figure 6: Typical Pulse Width Distortion vs. Temperature



Application Information

Bypassing and PC Board Layout

The HCPL-7723/0723 optocouplers are extremely easy to use. No external interface circuitry is required because the HCPL-7723/0723 use high-speed CMOS IC technology allowing CMOS logic to be connected directly to the inputs and outputs.

As shown in [Figure 7](#), the only external components required for proper operation are two bypass capacitors. Capacitor values should be between 0.01 μF and 0.1 μF . Each capacitor should be placed as close as possible to the input and output power-supply pins of the optocoupler.

Figure 7: Functional Diagram



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